

## 54F/74F219 64-Bit Random Access Memory with TRI-STATE® Outputs

### **General Description**

The 'F219 is a high-speed 64-bit RAM organized as a 16-word by 4-bit array. Address inputs are buffered to minimize loading and are fully decoded on-chip. The outputs are TRI-STATE and are in the high-impedance state whenever the Chip Select ( $\overline{CS}$ ) input is HIGH. The outputs are active only in the Read mode. This device is similar to the 'F189 but features non-inverting, rather than inverting, data outputs.

### **Features**

- TRI-STATE outputs for data bus applications
- Buffered inputs minimize loading
- Address decoding on-chip
- Diode clamped inputs minimize ringing
- Available in SOIC (300 mil only)

Commercial	Military	Package Number	Package Description			
74F219PC		N16E	16-Lead (0.300" Wide) Molded Dual-In-Line			
	54F219DL (Note 2)	J16A	16-Lead Ceramic Dual-In-Line			
74F219SC (Note 1)		M16B	16-Lead (0.300" Wide) Molded Small Outline, JEDEC			
74F219SJ (Note 1)		M16D	16-Lead (0.300" Wide) Molded Small Outline, EIAJ			
	54F219FL (Note 2)	W16A	16-Lead Cerpack			
	54F219LL (Note 2)	E20A	20-Lead Ceramic Leadless Chip Carrier, Type C			

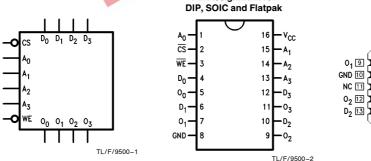
Pin Assignment for

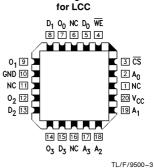
Note 1: Devices also available in 13" reel. Use suffix = SCX and SJX.

Note 2: Military grade device with environmental and burn-in processing. Use suffix = DLQB, FLQB and LLQB.

### **Logic Symbol**

### **Connection Diagrams**





Pin Assignment

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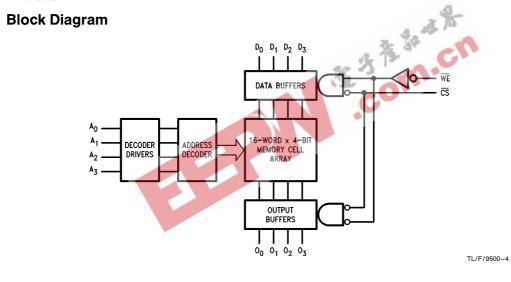
# Unit Loading/Fan Out

		54F/74F			
Pin Names	Description	U.L. HIGH/LOW	Input I <sub>IH</sub> /I <sub>IL</sub> Output I <sub>OH</sub> /I <sub>OL</sub>		
A <sub>0</sub> -A <sub>3</sub>	Address Inputs	1.0/1.0	20 μA/ – 0.6 mA		
CS	Chip Select Input (Active LOW)	1.0/2.0	20 μA/ – 1.2 mA		
WE	Write Enable Input (Active LOW)	1.0/1.0	20 μA/ -0.6 mA		
D <sub>0</sub> -D <sub>3</sub>	Data Inputs	1.0/1.0	20 μA/ -0.6 mA		
O <sub>0</sub> -O <sub>3</sub>	TRI-STATE Data Outputs	150/40 (33.3)	−3 mA/24 mA (20 mA)		

### Function Table

Inputs		Operation	Condition of Outputs				
CS	WE	Operation	Containion of Outputs				
L	L	Write	High Impedance				
L	Н	Read	True Stored Data				
Н	X	Inhibit	High Impedance				

- $$\begin{split} H &= \text{HIGH Voltage Level} \\ L &= \text{LOW Voltage Level} \\ X &= \text{Immaterial} \end{split}$$



### Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

 $\begin{array}{lll} \mbox{Storage Temperature} & -65^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \mbox{Ambient Temperature under Bias} & -55^{\circ}\mbox{C to} + 125^{\circ}\mbox{C} \\ \mbox{Junction Temperature under Bias} & -55^{\circ}\mbox{C to} + 175^{\circ}\mbox{C} \\ \mbox{Plastic} & -55^{\circ}\mbox{C to} + 150^{\circ}\mbox{C} \\ \end{array}$ 

 $\begin{array}{lll} \text{V}_{\text{CC}} \text{ Pin Potential to} & & & \\ \text{Ground Pin} & & -0.5 \text{V to } +7.0 \text{V} \\ \text{Input Voltage (Note 2)} & & -0.5 \text{V to } +7.0 \text{V} \\ \text{Input Current (Note 2)} & & -30 \text{ mA to } +5.0 \text{ mA} \end{array}$ 

Voltage Applied to Output

in HIGH State (with  $V_{CC} = 0V$ )

 $\begin{array}{lll} \text{Standard Output} & -0.5 \text{V to V}_{\text{CC}} \\ \text{TRI-STATE Output} & -0.5 \text{V to } +5.5 \text{V} \end{array}$ 

Current Applied to Output

in LOW State (Max) twice the rated I<sub>OL</sub> (mA)

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

# **Recommended Operating Conditions**

Free Air Ambient Temperature

Military  $-55^{\circ}\text{C to} + 100^{\circ}\text{C}$ Commercial  $0^{\circ}\text{C to} + 70^{\circ}\text{C}$ 

Supply Voltage

Military + 4.5V to +5.5V

Commercial + 4.5V to +5.5V

### **DC Electrical Characteristics**

Symbol	Parameter -		54F/74F			Units	Vaa	Conditions	
Syllibol			Min	Тур	Max	Ullits	V <sub>CC</sub>	Conditions	
V <sub>IH</sub>	Input HIGH Voltage		2.0			V		Recognized as a HIGH Signal	
V <sub>IL</sub>	Input LOW Voltage				0.8	V	1	Recognized as a LOW Signal	
V <sub>CD</sub>	Input Clamp Diode Vo	Itage			-1.2	V	Min	I <sub>IN</sub> = −18 mA	
V <sub>OH</sub>	Output HIGH Voltage	54F 10% V <sub>CC</sub> 54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub> 74F 5% V <sub>CC</sub> 74F 5% V <sub>CC</sub>	2.5 2.4 2.5 2.4 2.7 2.7	1	36	o V	Min	$I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -1 \text{ mA}$ $I_{OH} = -3 \text{ mA}$	
$V_{OL}$	Output LOW Voltage	54F 10% V <sub>CC</sub> 74F 10% V <sub>CC</sub>			0.5 0.5	V	Min	$I_{OL} = 20 \text{ mA}$ $I_{OL} = 24 \text{ mA}$	
I <sub>IH</sub>	Input HIGH Current	54F 74F			20.0 5.0	μΑ	Max	V <sub>IN</sub> = 2.7V	
I <sub>BVI</sub>	Input HIGH Current Breakdown Test	54F 74F			100 7.0	μΑ	Max	V <sub>IN</sub> = 7.0V	
I <sub>CEX</sub>	Output HIGH Leakage Current	54F 74F			250 50	μΑ	Max	$V_{OUT} = V_{CC}$	
V <sub>ID</sub>	Input Leakage Test	74F	4.75			V	0.0	$I_{\text{ID}} = 1.9 \ \mu\text{A}$ All Other Pins Grounded	
I <sub>OD</sub>	Output Leakage Circuit Current	74F			3.75	μΑ	0.0	V <sub>IOD</sub> = 150 mV All Other Pins Grounded	
I <sub>IL</sub>	Input LOW Current				-0.6 -1.2	mA	Max	$V_{IN} = 0.5V (A_n, \overline{WE}, D_n)$ $V_{IN} = 0.5V (\overline{CS})$	
lozh	Output Leakage Curre	ent			50	μΑ	Max	V <sub>OUT</sub> = 2.7V	
I <sub>OZL</sub>	Output Leakage Curre	ent			-50	μΑ	Max	V <sub>OUT</sub> = 0.5V	
los	Output Short-Circuit C	urrent	-60		-150	mA	Max	V <sub>OUT</sub> = 0V	
I <sub>ZZ</sub>	Bus Drainage Test				500	μΑ	0.0V	V <sub>OUT</sub> = 5.25V	
Icc	Power Supply Current			37	55	mA	Max		

# **AC Electrical Characteristics**

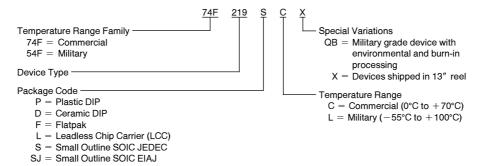
					54F		74F		Units
Symbol	Parameter				$T_{A}=+100^{\circ} C$ $V_{CC}=Mil$ $C_{L}=50~pF$		T <sub>A</sub> , V <sub>CC</sub> = Com C <sub>L</sub> = 50 pF		
		Min	Тур	Max	Min	Max	Min	Max	
t <sub>PLH</sub>	Access Time, HIGH or LOW $A_n$ to $O_n$	10.0 8.0	18.5 13.5	26.0 19.0	9.0 8.0	32.0 23.0	10.0 8.0	27.0 20.0	ns
t <sub>PZH</sub>	Access Time, HIGH or LOW CS to On	3.5 5.0	6.0 9.0	8.5 13.0	3.5 5.0	10.5 15.0	3.5 5.0	9.5 14.0	ns
t <sub>PHZ</sub>	Disable Time, HIGH or LOW CS to On	2.0 3.0	4.0 5.5	6.0 8.0	2.0 2.5	8.0 10.0	2.0 3.0	7.0 9.0	113
t <sub>PZH</sub>	Write Recovery Time HIGH or LOW, WE to O <sub>n</sub>	6.5 6.5	20.0 11.0	28.0 15.5	6.5 6.5	37.5 17.5	6.5 6.5	29.0 16.5	ns
t <sub>PHZ</sub>	Disable Time, HIGH or LOW $\overline{\text{WE}}$ to $\text{O}_{\text{n}}$	4.0 5.0	7.0 9.0	10.0 13.0	3.5 5.0	12.0 15.0	4.0 5.0	11.0 14.0	113

# **AC Operating Requirements**

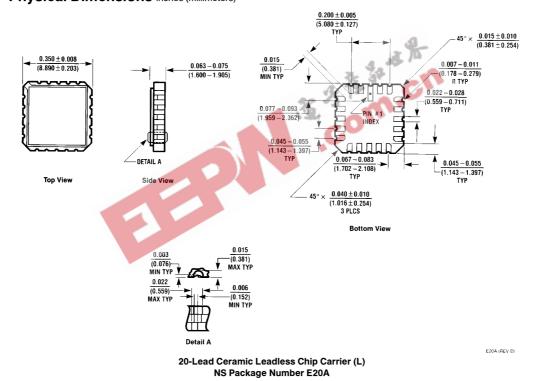
		74F			54F 35.	74F		
Symbol Parameter		$T_A = +25^{\circ}C$ $V_{CC} = +5.0V$		Vc	+ 100°C C = Mil	T <sub>A</sub> , V <sub>CC</sub> = Com		Units
ļ		Min	Max	Min	Max	Min	Max	
t <sub>s</sub> (H) t <sub>s</sub> (L)	Setup Time, HIGH or LOW A <sub>n</sub> to WE	0 0		0	.00	0 0		ns
t <sub>h</sub> (H)	Hold Time, HIGH or LOW A <sub>n</sub> to WE	2.0 2.0		2.0 2.0		2.0 2.0		113
t <sub>S</sub> (H) t <sub>S</sub> (L)	Setup Time, HIGH or LOW D <sub>n</sub> to WE	10.0 10.0	3	11.0 11.0		10.0 10.0		ns
t <sub>h</sub> (H)	Hold Time, HIGH or LOW D <sub>n</sub> to WE	0		2.0 2.0		0 0		113
t <sub>s</sub> (L)	Setup Time, LOW  CS to WE	0		0		0		ns
t <sub>h</sub> (L)	Hold Time, LOW CS to WE	6.0		7.5		6.0		115
t <sub>w</sub> (L)	WE Pulse Width, LOW	6.0		15.0		6.0		ns

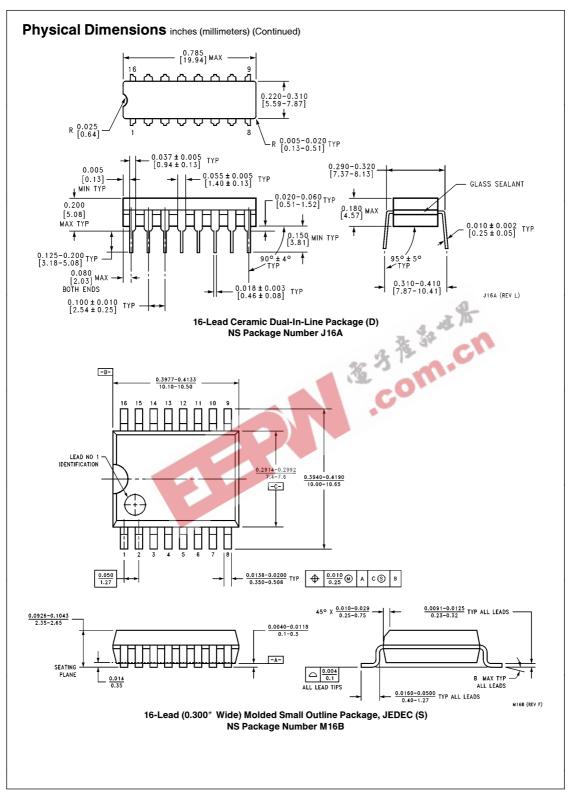
### **Ordering Information**

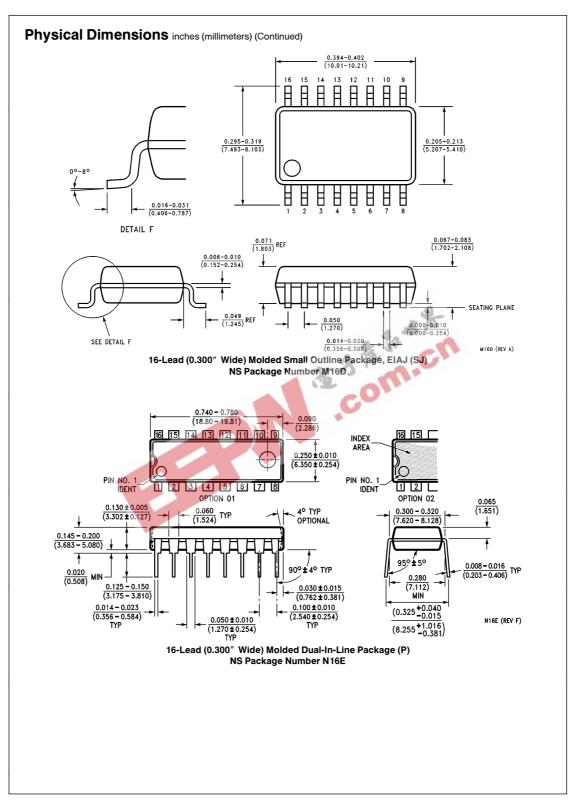
The device number is used to form part of a simplified purchasing code where the package type and temperature range are defined as follows:



### Physical Dimensions inches (millimeters)







### Physical Dimensions inches (millimeters) (Continued) $\frac{0.050 - 0.080}{(1.270 - 2.032)}$ 0.371 - 0.390(9.423 - 9.906) $\frac{0.050\pm0.005}{(1.270\pm0.127)} \text{ TYP}$ 0.004 - 0.0060.007 - 0.018 (0.178 – 0.457) TYP $\overline{(0.102 - 0.152)}$ **←** 0.000 MIN TYP 0.250 - 0.370 (6.350 - 9.398)0.300 0.245 - 0.275(7.620) MAX GLASS $\overline{(6.223-6.985)}$ ٧ 0.008 - 0.012(0.203 - 0.305)DETAIL A PIN NO. 1 0.250 - 0.370DETAIL A IDENT (6.350 - 9.398)0.026 - 0.0400.015 - 0.019(0.381 - 0.482)(0.660 - 1.016)16-Lead Ceramic Flatpak (F) 16-Lead Ceramic Flagues W NS Package Number W16A

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